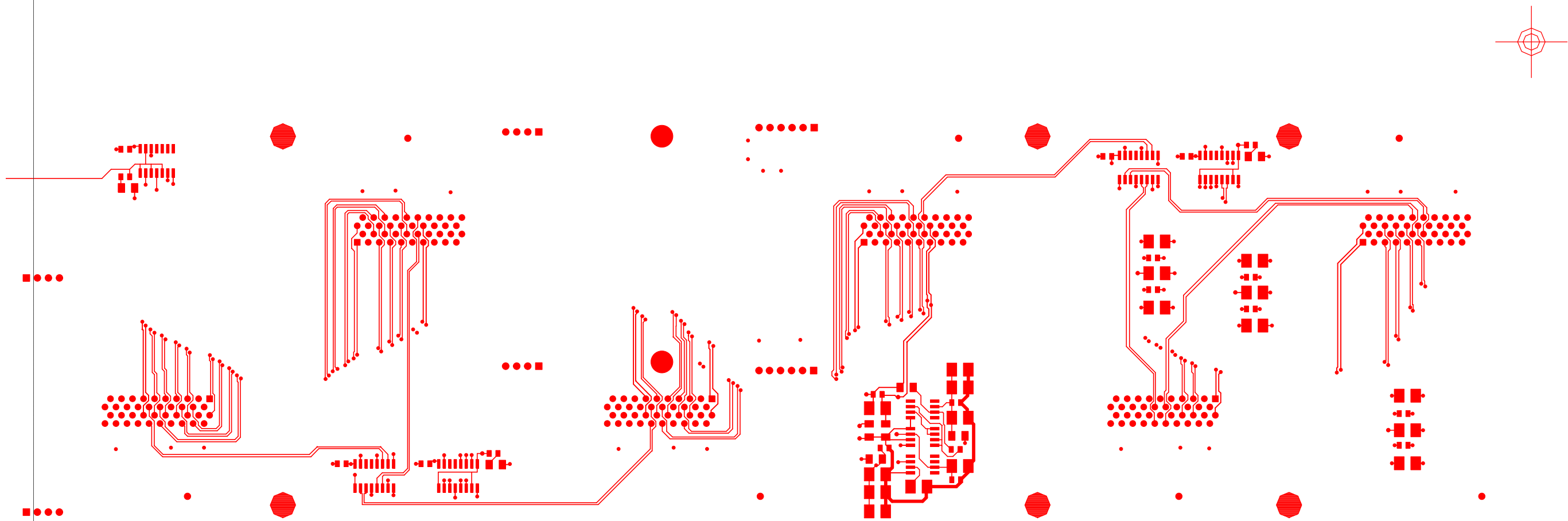
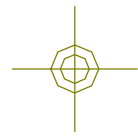
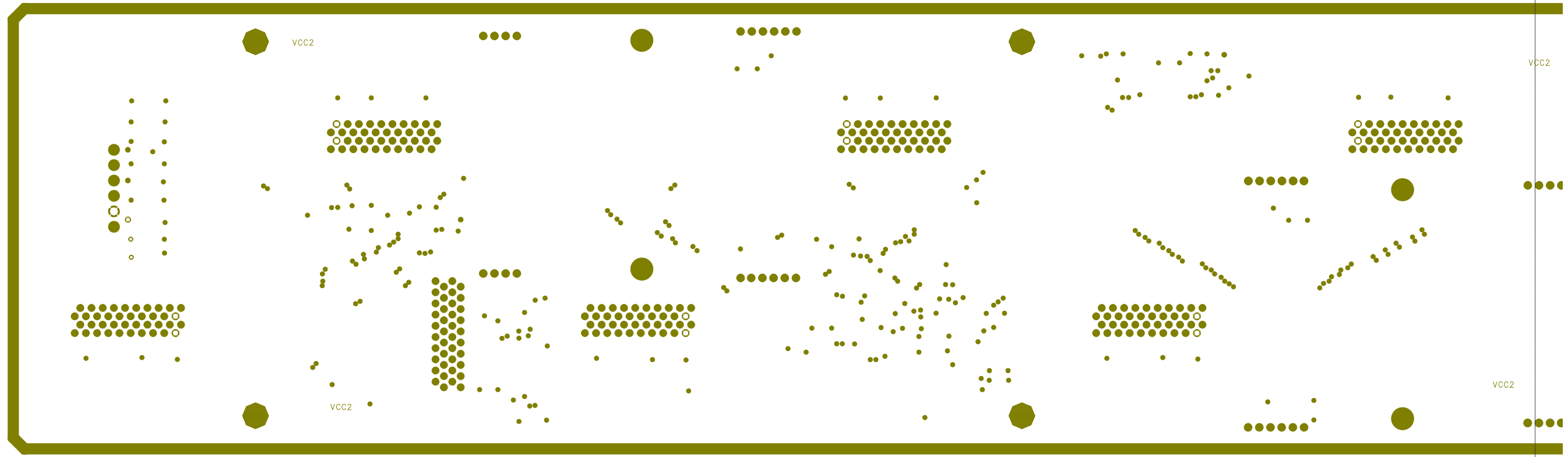


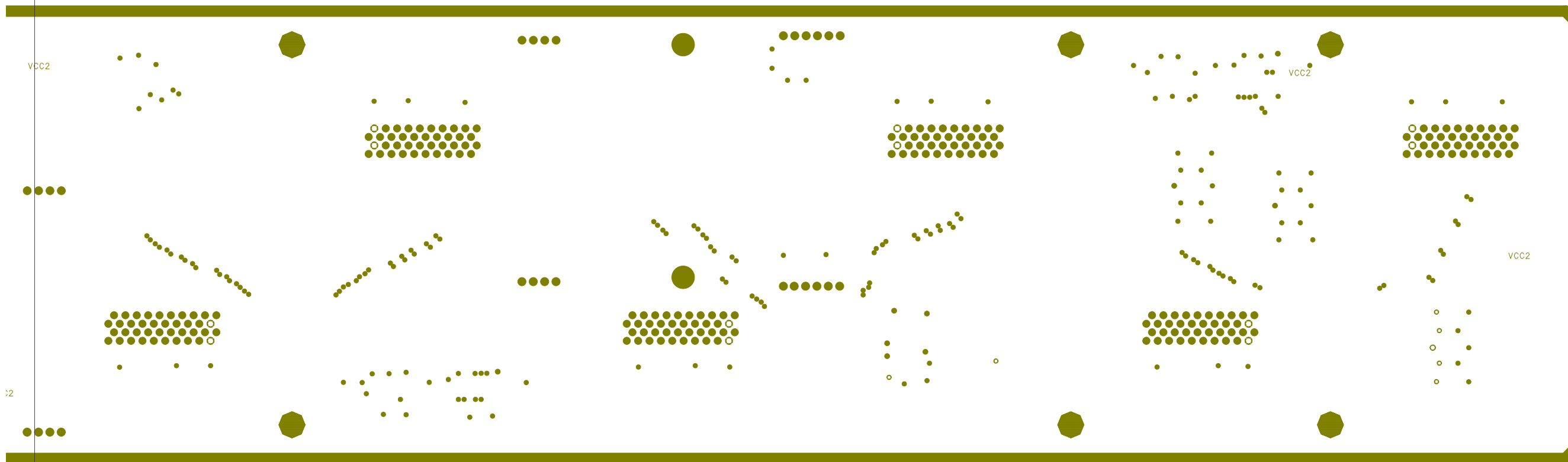
FILM1:Top Component Lay



Layer (Signal_1)



FILM2: Power Plane (VCC2)



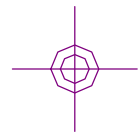
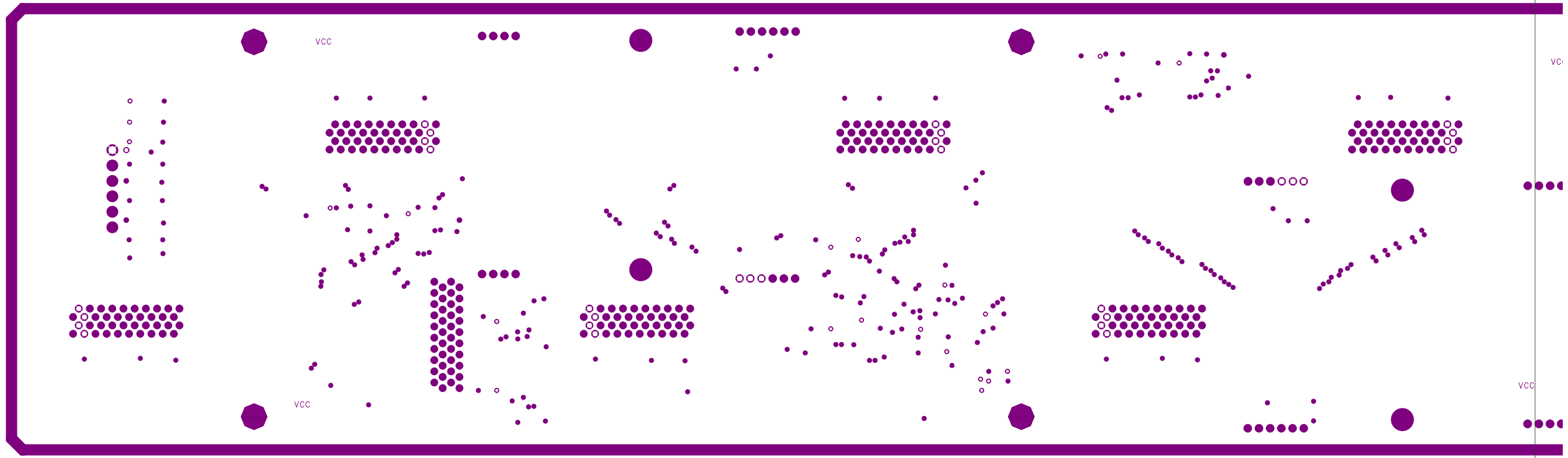
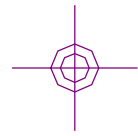
VCC2

VCC2

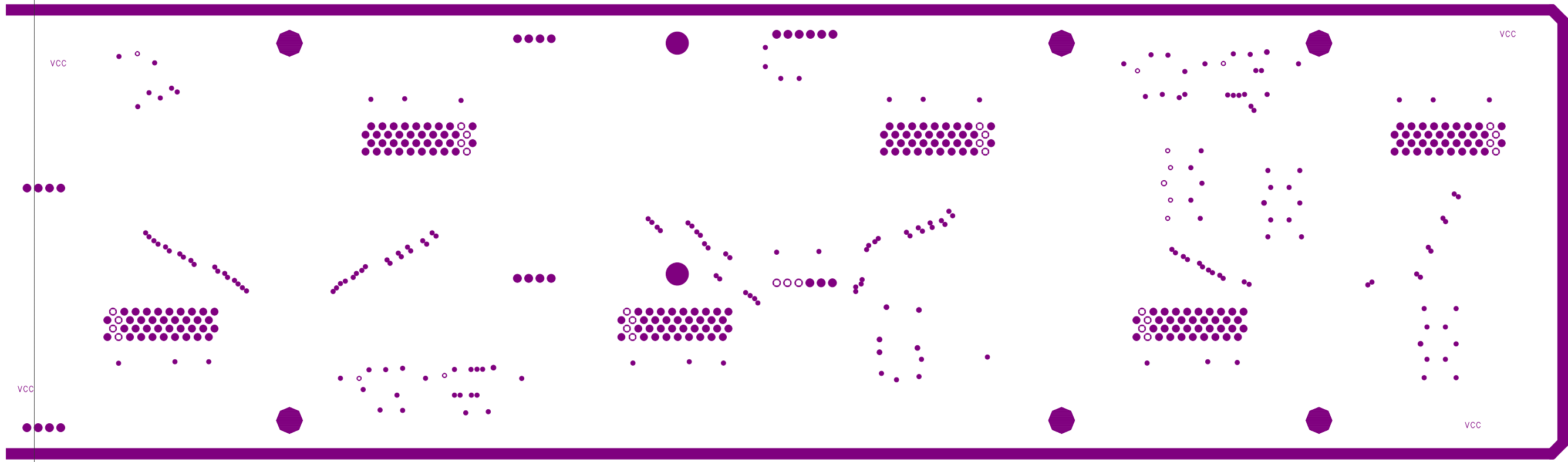
VCC2

2

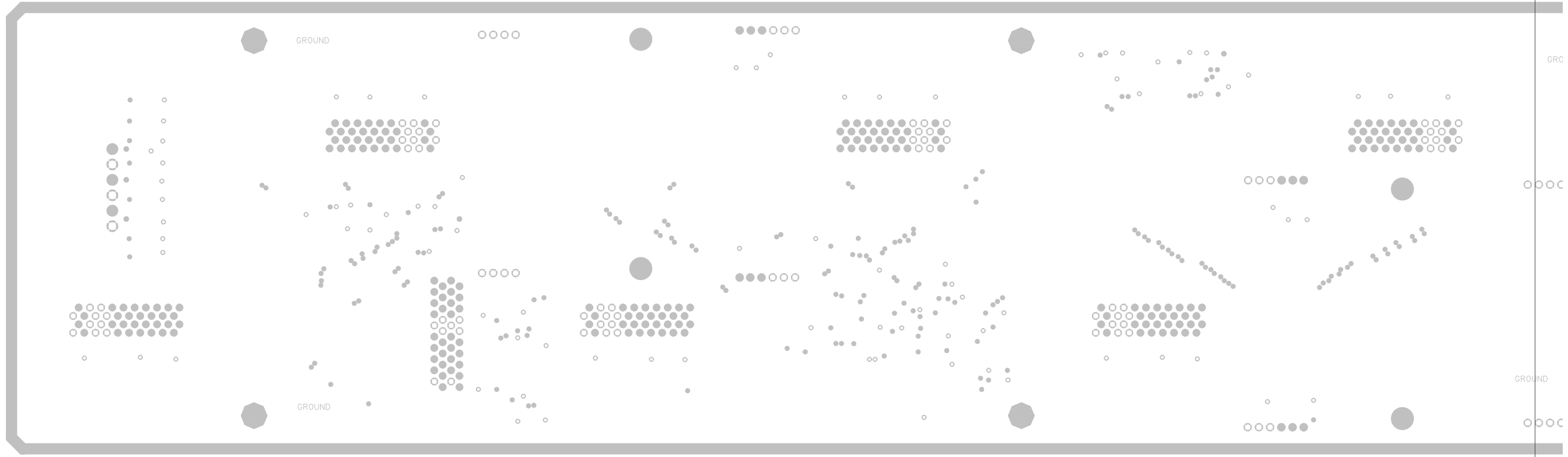
VCC2)



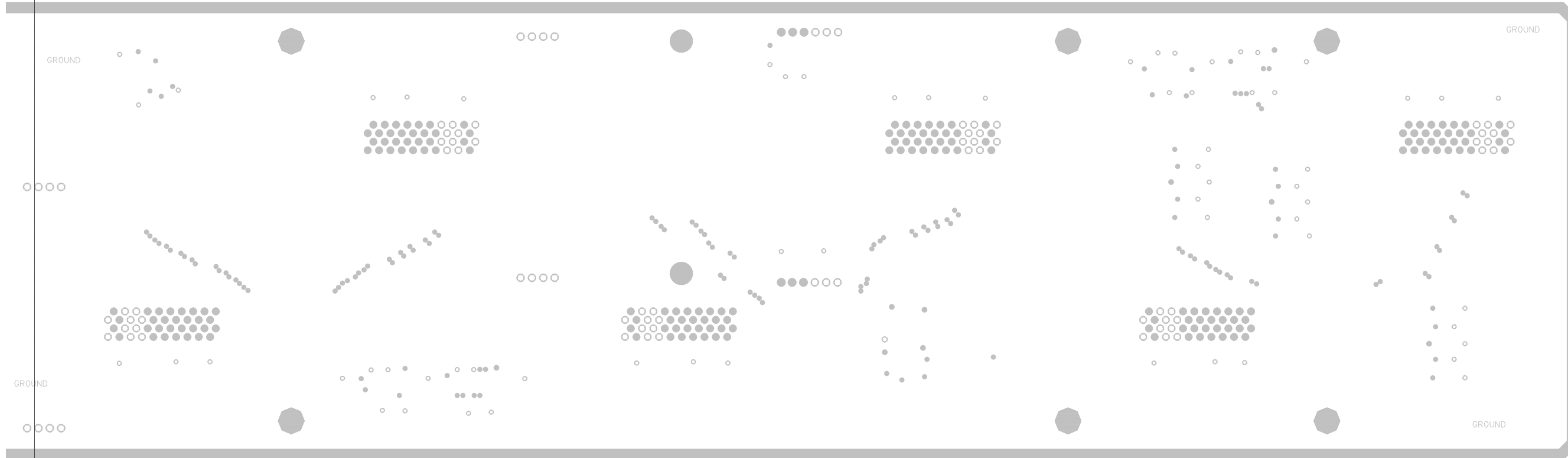
FILM3: Power Plane (VCC)



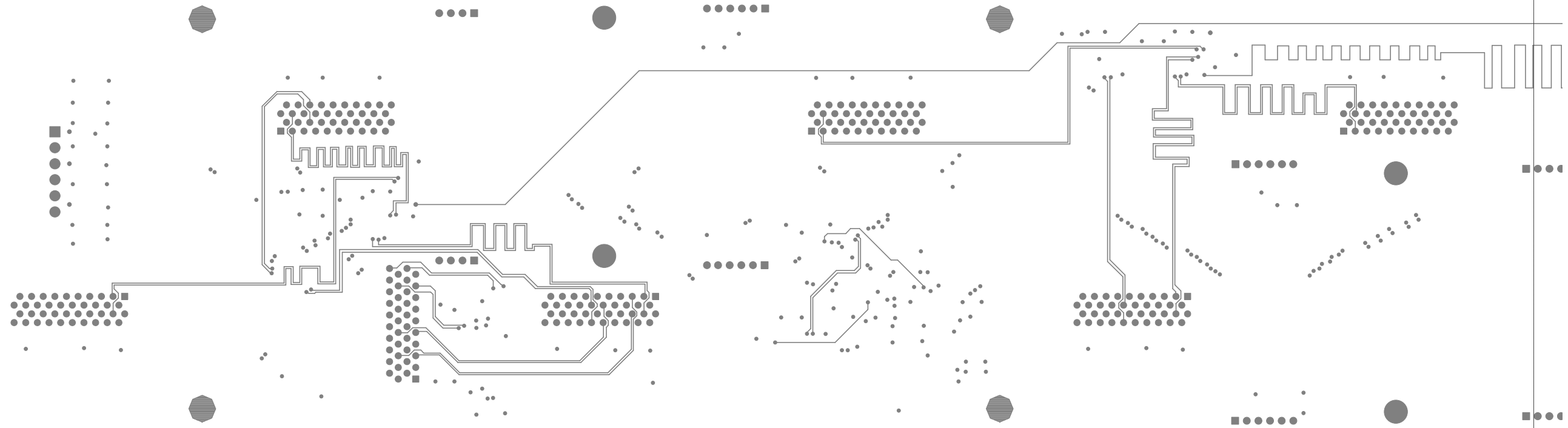
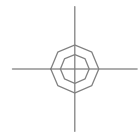
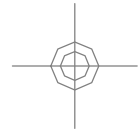
VCC)



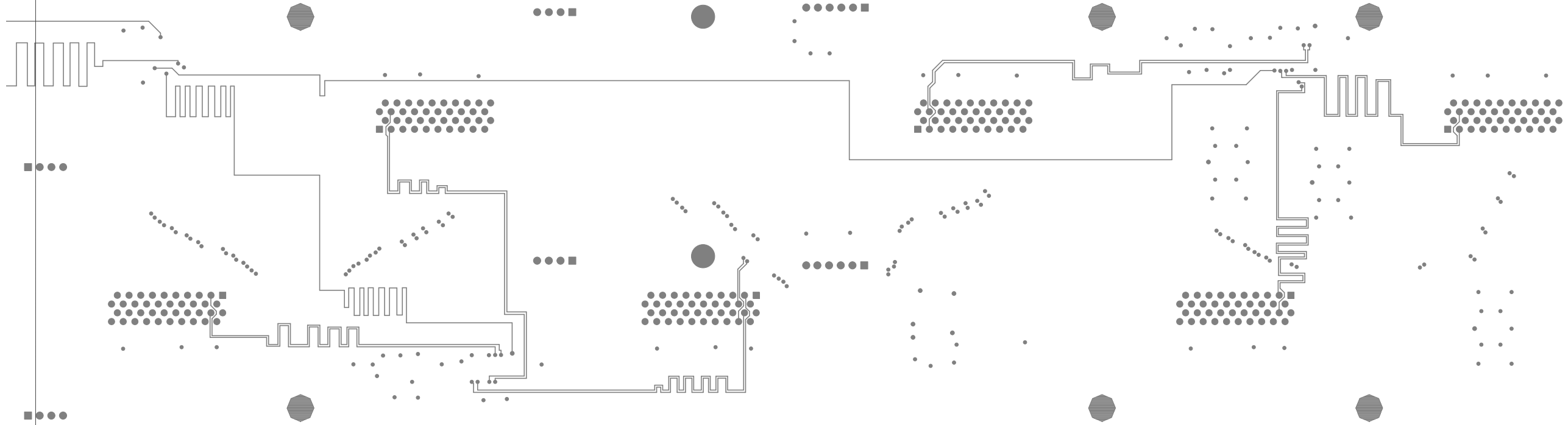
FILM4: Power Plane (GRO



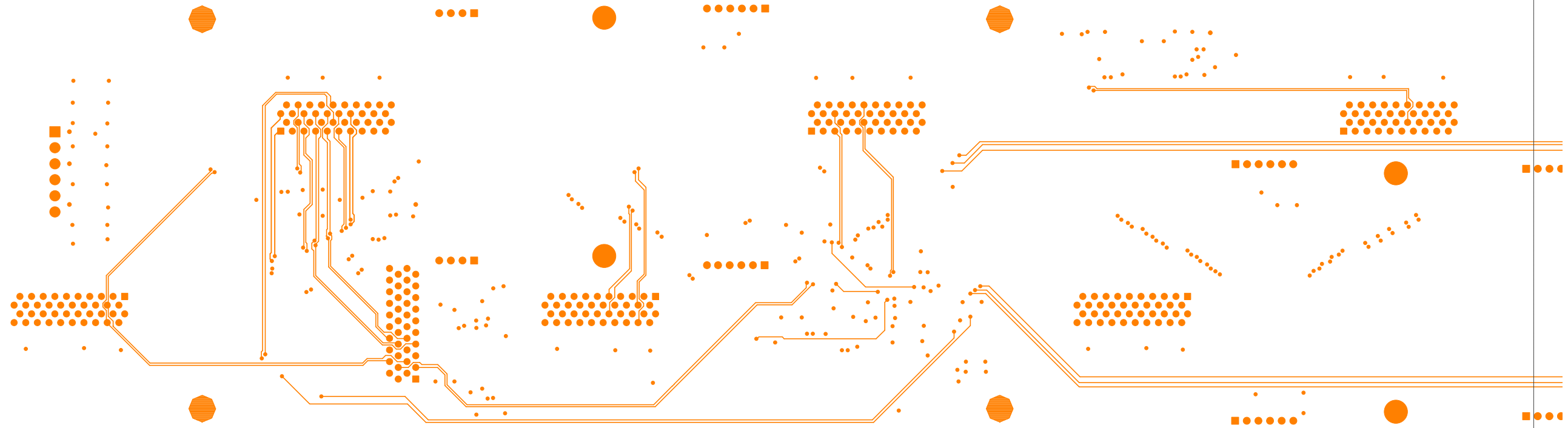
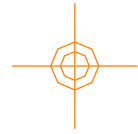
GROUND)



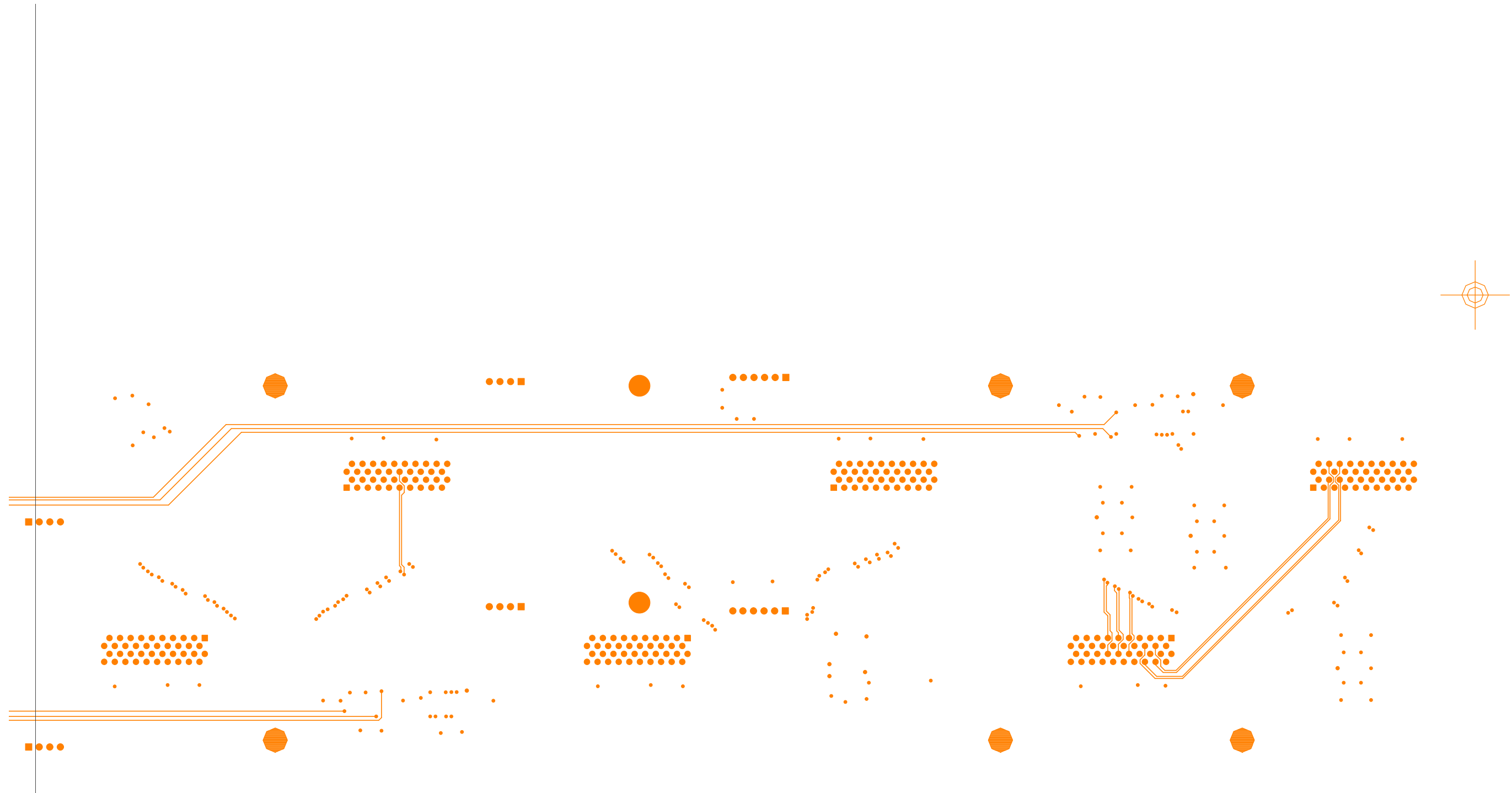
FILM5: Inner Signal Layer



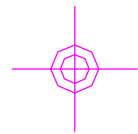
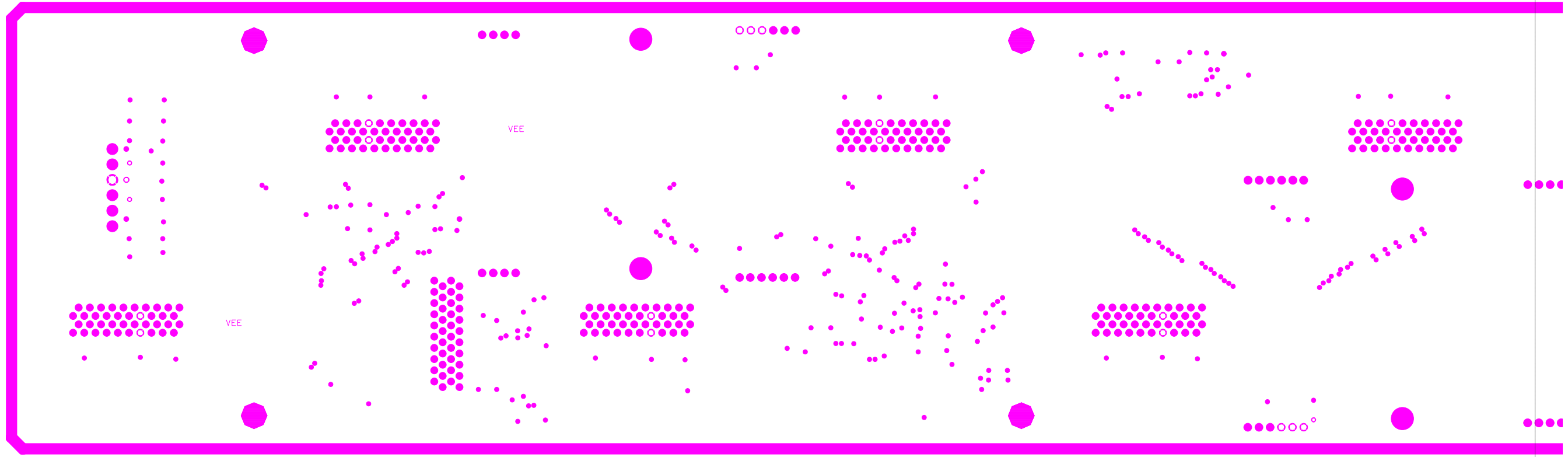
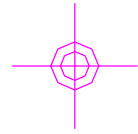
_ayer (Signal_3)



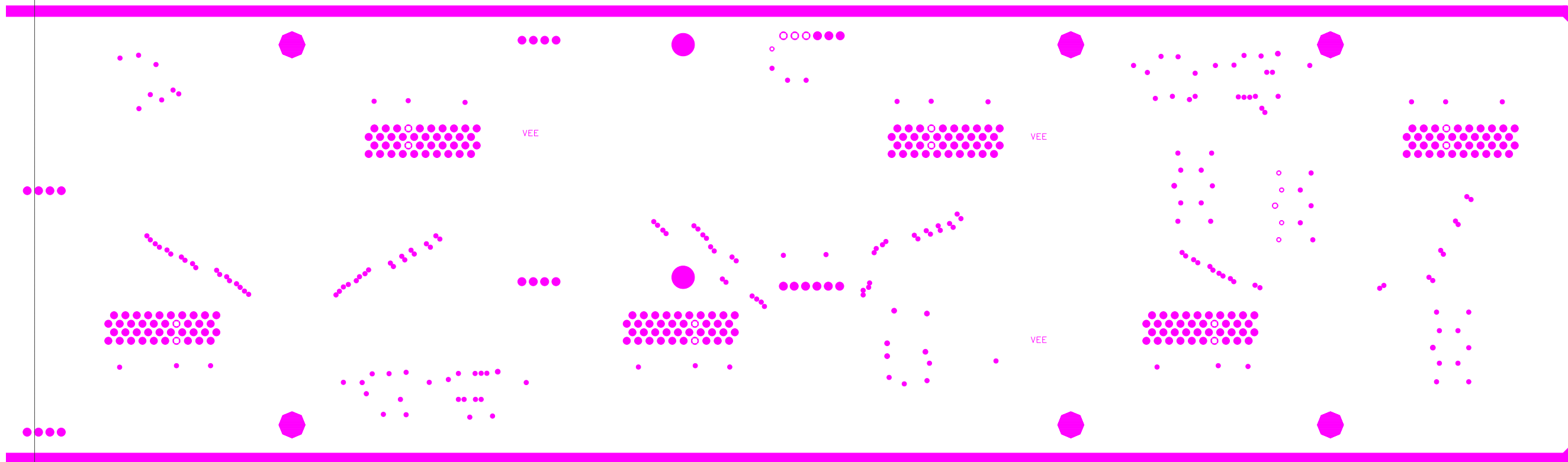
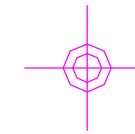
FILM6: Inner Signal Layer



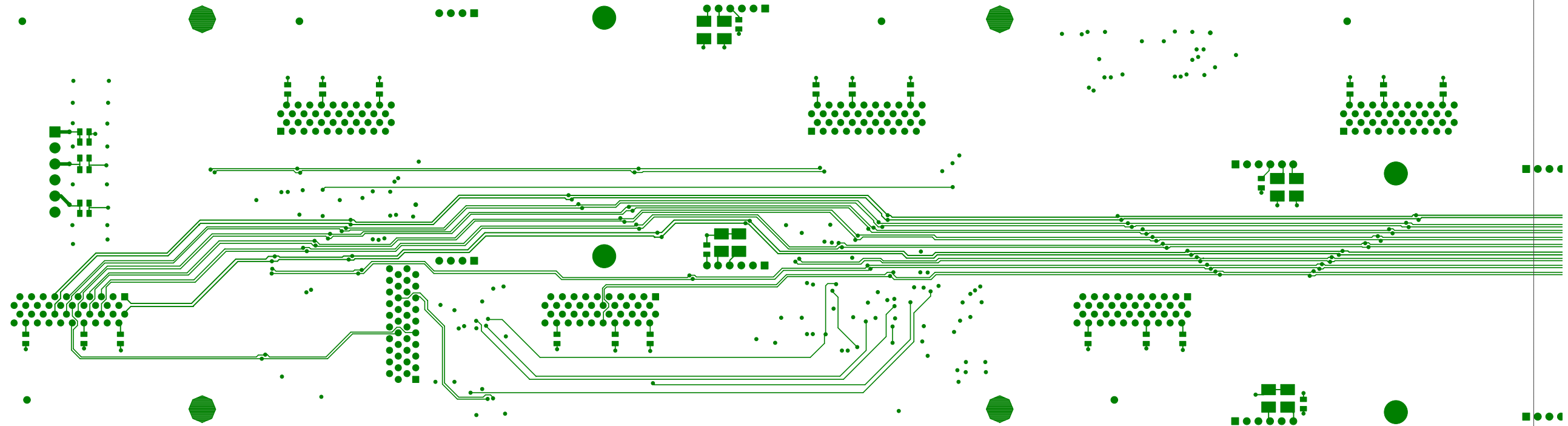
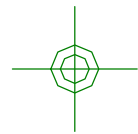
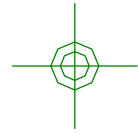
ayer (Signal_4)



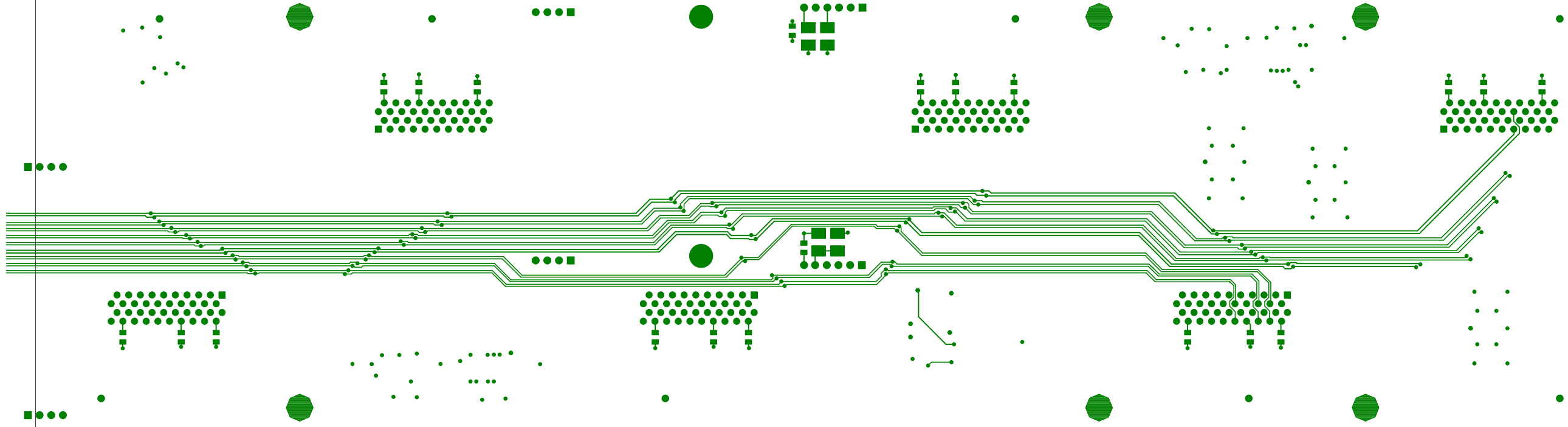
FILM7: Power Plane (VEE)



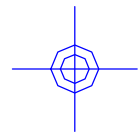
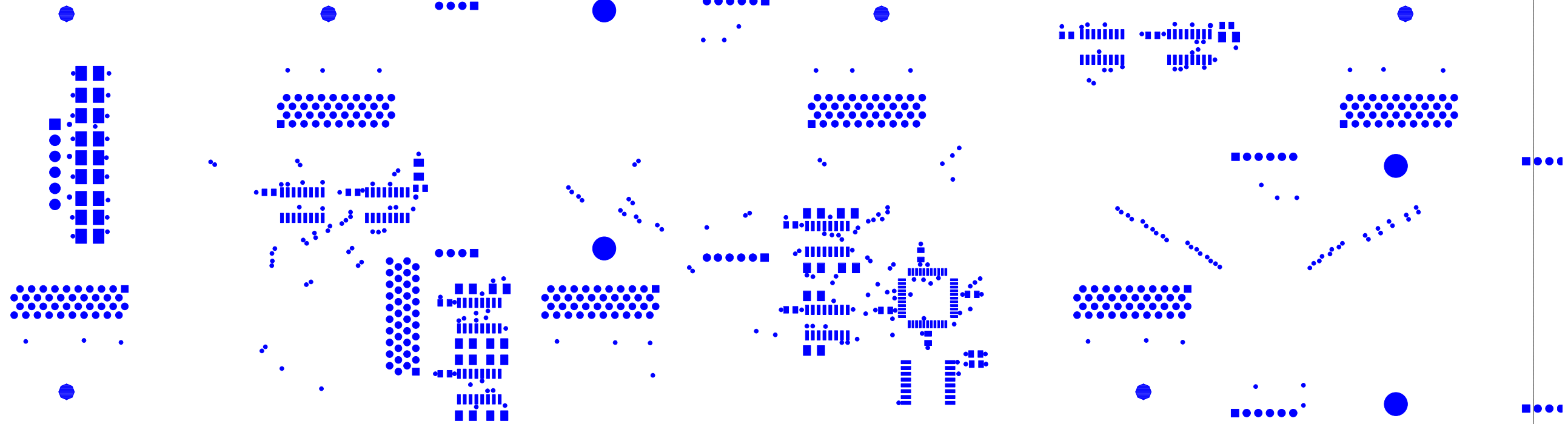
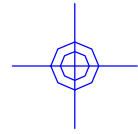
VEE)



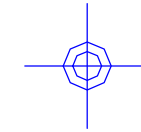
Component Layer (Signal_2)



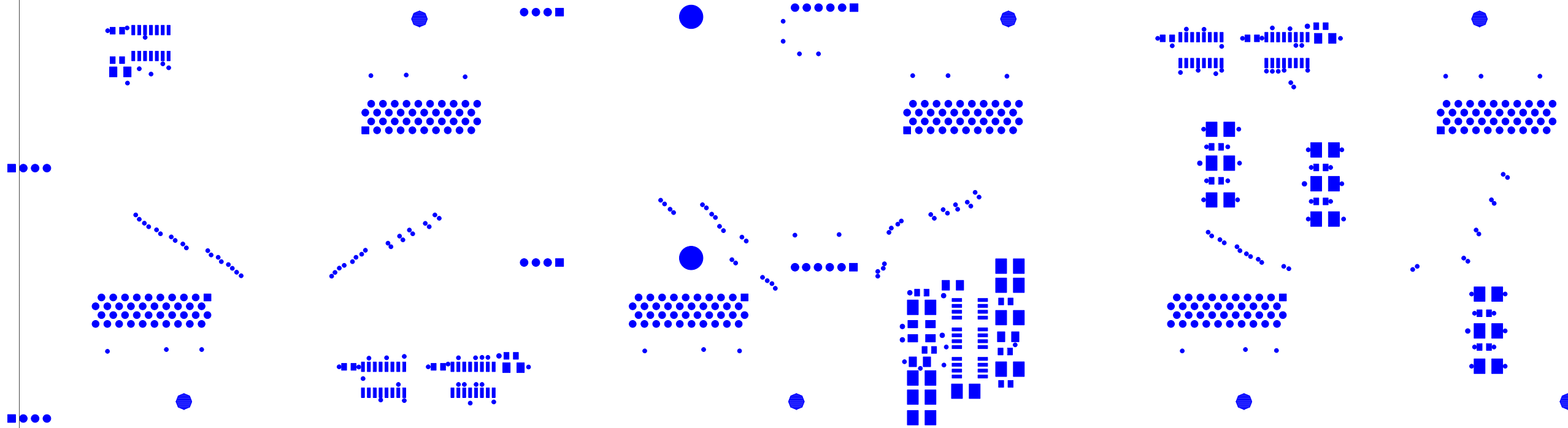
FILM8 : Bottom Comp

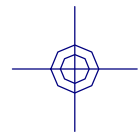
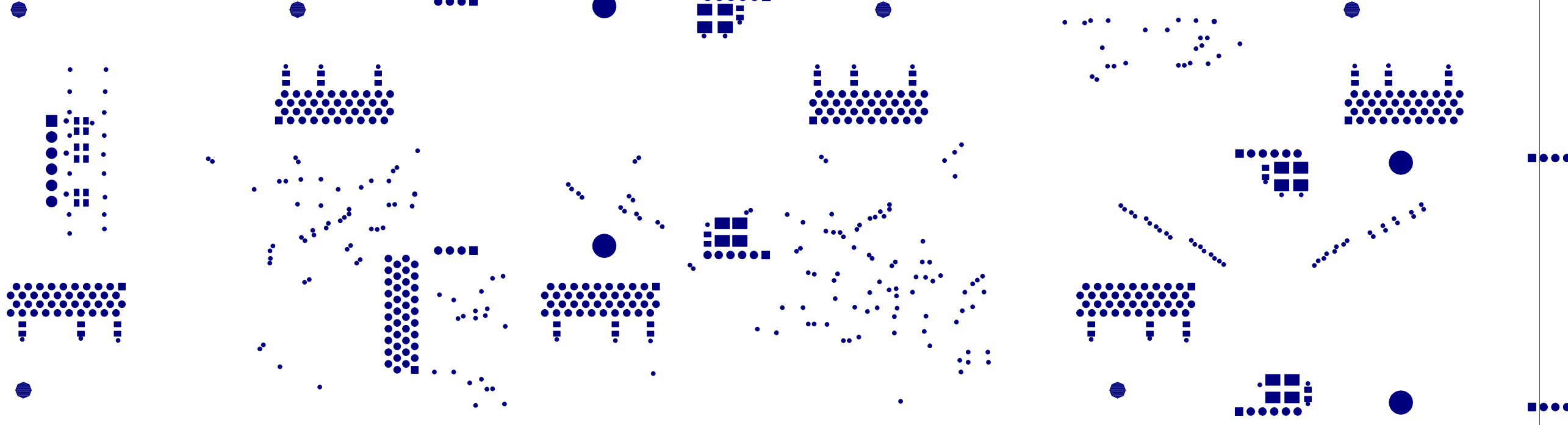
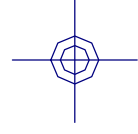


FILM9: (Top Solder Mask)

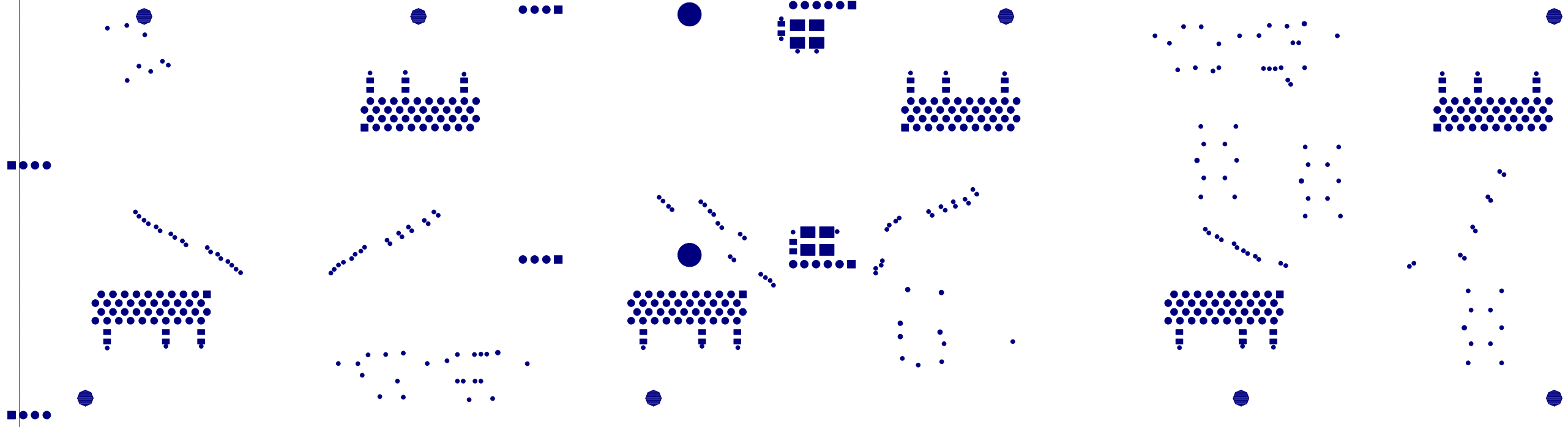
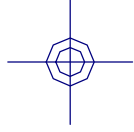


ask)

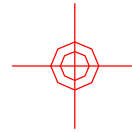




10 : (Bottom Silver Mask)



FILMIO:

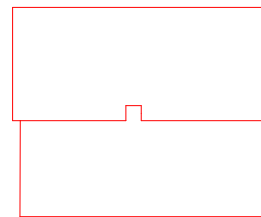
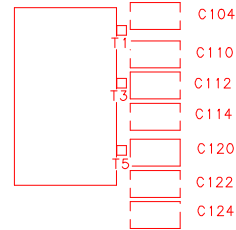


MOTHERBOARD SECTION-4

BAR CODE

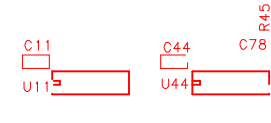
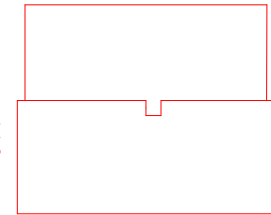
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JP1

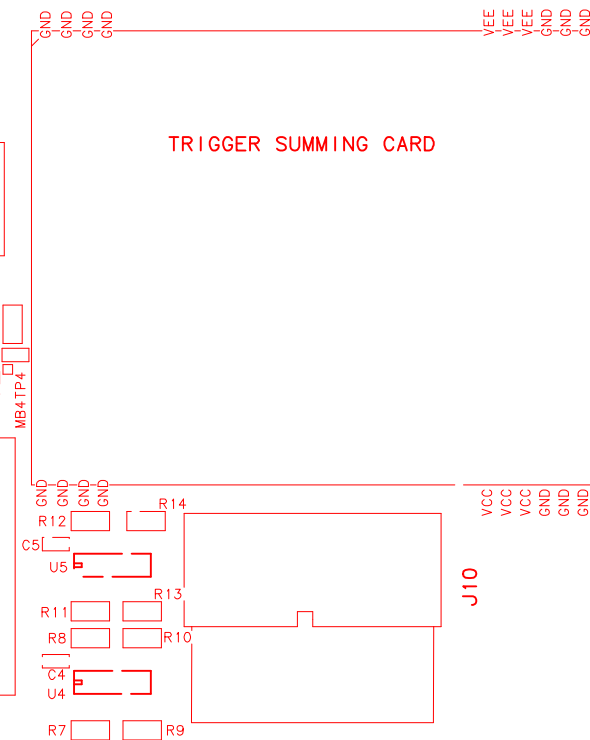
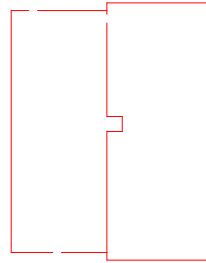


SCH# B2318 V3.1
SPC# B2319 V3.1
ASM# B2320 V3.1

J11

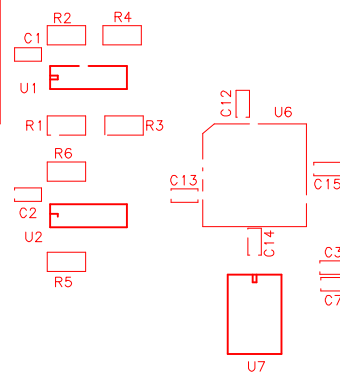


EJ0

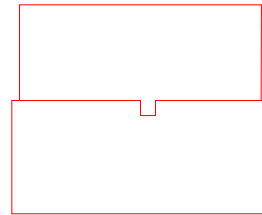


TRIGGER SUMMING CARD

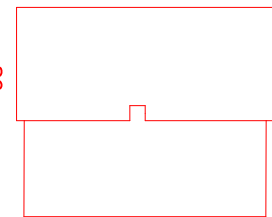
TJ3
TRIGGER SUMMING CARD



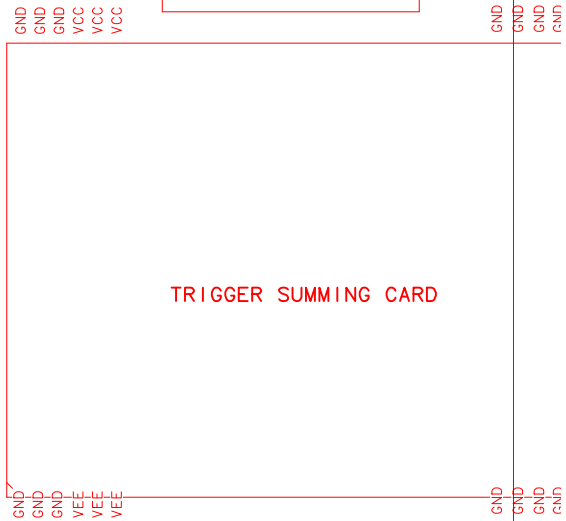
J9



J8

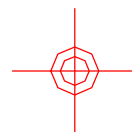
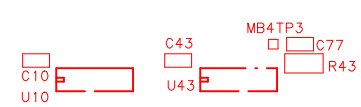
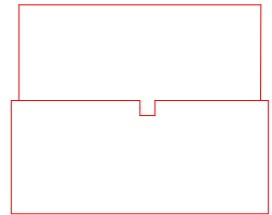


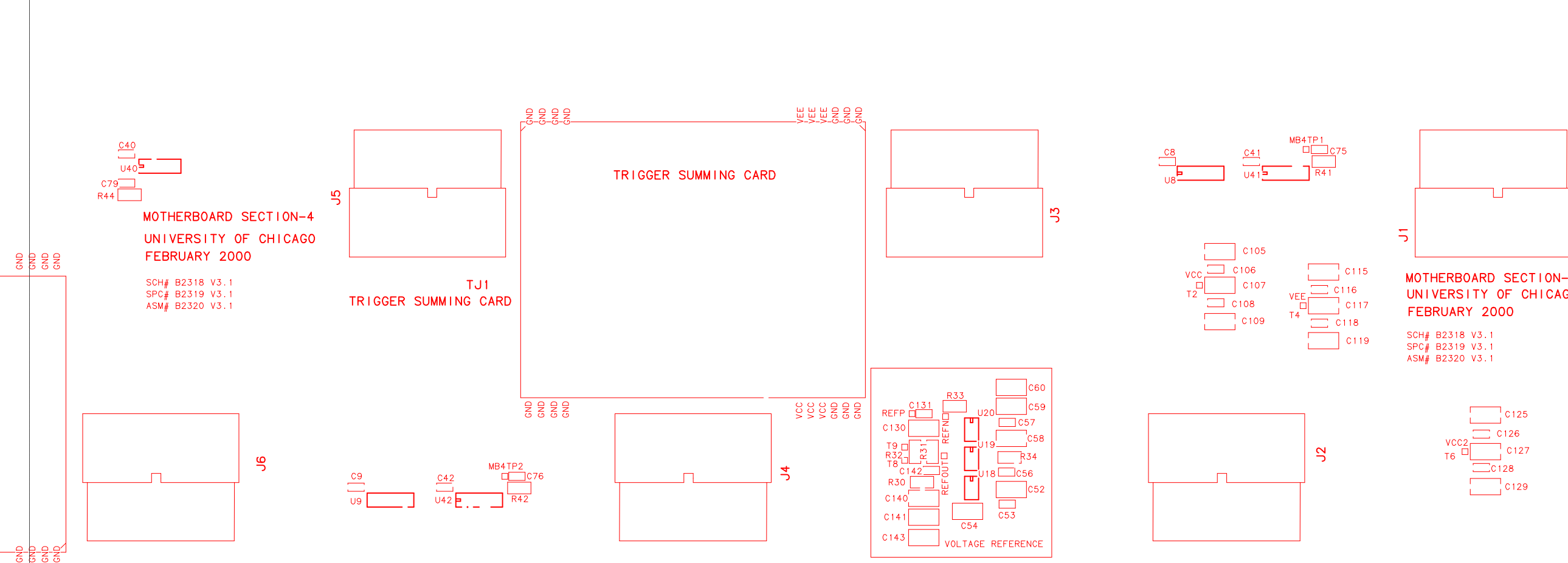
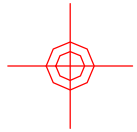
TJ2
TRIGGER SUMMING CARD



TRIGGER SUMMING CARD

J7

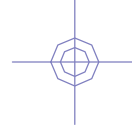
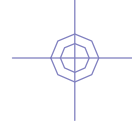




MOTHERBOARD SECTION-4
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SCH# B2318 V3.1
SPC# B2319 V3.1
ASM# B2320 V3.1

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SCH# B2318 V3.1
SPC# B2319 V3.1
ASM# B2320 V3.1

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C153
C151
C111
C113
C103
C101

C234
C232
C236

C332
C335
C331

FEBRUARY 2000
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MOTHERBOARD SECTION-4
V2W# B3350 V3.1
2PC# B3219 V3.1
SCH# B3318 V3.1

C338
C336
C320

C315
C313
C314

C312
C318
C311

C333
C338
C339

C333
C332
C334

C308
C310
C311

C309
C307
C308

C331
C330
C319

ILM12: (Top Silk_screen)



V2M# B5350 V3.1
SPC# B5319 V3.1
SCH# B5318 V3.1
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MOTHERBOARD SECTION-4

10E3
20E3
30E3

40E3
50E3
60E3

70E3

80E3
90E3
100E3

110E3
120E3
130E3

140E3
150E3
160E3

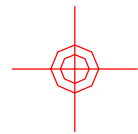
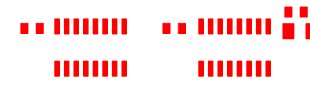
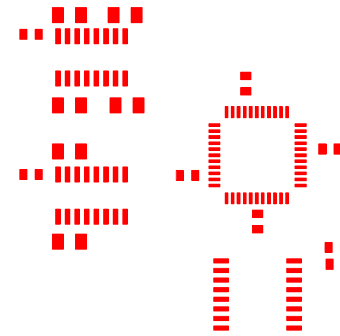
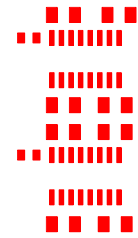
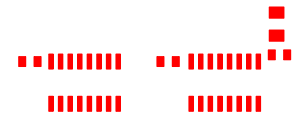
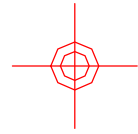
170E3
180E3
190E3

200E3
210E3
220E3

230E3
240E3
250E3

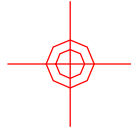
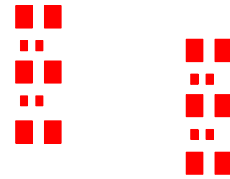
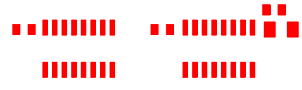
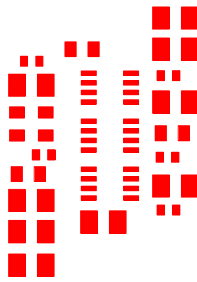
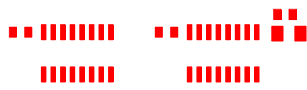
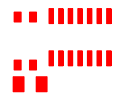
V2M# B5350 V3.1
SPC# B5319 V3.1
SCH# B5318 V3.1
FEBRUARY 2000
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MOTHERBOARD SECTION-4

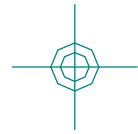
FILM 1



FILM13: (Top Paste Mask)

sk)





M14 : (Bottom Paste Mask)

FILM 14



